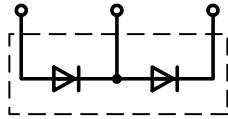
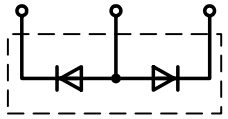
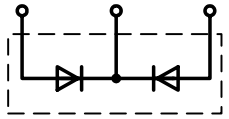


## Dual Diode Modules MD# 600

### Absolute Maximum Ratings

| $V_{RRM}$<br>$V_{DRM}$<br>[M] | <br>MDD | <br>MDA | <br>MDK |
|-------------------------------|------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------|
| 1200                          | 600-12N1                                                                                 | 600-12N1                                                                                  | 600-12N1                                                                                   |
| 1400                          | 600-14N1                                                                                 | 600-14N1                                                                                  | 600-14N1                                                                                   |
| 1600                          | 600-16N1                                                                                 | 600-16N1                                                                                  | 600-16N1                                                                                   |
| 1800                          | 600-18N1                                                                                 | 600-18N1                                                                                  | 600-18N1                                                                                   |
| 2000                          | 600-20N1                                                                                 | 600-20N1                                                                                  | 600-20N1                                                                                   |
| 2200                          | 600-22N1                                                                                 | 600-22N1                                                                                  | 600-22N1                                                                                   |

|           | VOLTAGE RATINGS                                   | MAXIMUM LIMITS | UNITS |
|-----------|---------------------------------------------------|----------------|-------|
| $V_{RRM}$ | Repetitive peak reverse voltage <sup>1)</sup>     | 1200-2200      | V     |
| $V_{RSM}$ | Non-repetitive peak reverse voltage <sup>1)</sup> | 1300-2300      | V     |

|               | OTHER RATINGS                                                                  | MAXIMUM LIMITS     | UNITS            |
|---------------|--------------------------------------------------------------------------------|--------------------|------------------|
| $I_{F(AV)M}$  | Maximum average forward current. $T_{case} = 111^{\circ}C$ <sup>2)</sup>       | 600                | A                |
| $I_{F(AV)M}$  | Maximum average forward current. $T_{case} = 85^{\circ}C$ <sup>2)</sup>        | 883                | A                |
| $I_{F(AV)M}$  | Maximum average forward current. $T_{case} = 100^{\circ}C$ <sup>2)</sup>       | 726                | A                |
| $I_{F(RMS)}$  | Nominal RMS forward current. $T_{case} = 55^{\circ}C$ <sup>2)</sup>            | 1818               | A                |
| $I_{F(D.C.)}$ | D.C. forward current. $T_{case} = 55^{\circ}C$                                 | 1158               | A                |
| $I_{TSM}$     | Peak non-repetitive surge $t_p = 10$ ms, $V_{RM} = 60\%V_{RRM}$ <sup>3)</sup>  | 21.8               | kA               |
| $I_{TSM2}$    | Peak non-repetitive surge $t_p = 10$ ms, $V_{RM} \leq 10$ V <sup>3)</sup>      | 24.0               | kA               |
| $I^2t$        | $I^2t$ capacity for fusing $t_p = 10$ ms, $V_{RM} = 60\%V_{RRM}$ <sup>3)</sup> | $2.38 \times 10^6$ | A <sup>2</sup> s |
| $I^2t$        | $I^2t$ capacity for fusing $t_p = 10$ ms, $V_{RM} \leq 10$ V <sup>3)</sup>     | $2.88 \times 10^6$ | A <sup>2</sup> s |
| $V_{isol}$    | Isolation Voltage <sup>4)</sup>                                                | 3500               | V                |
| $T_{j op}$    | Operating temperature range                                                    | -40 to +125        | °C               |
| $T_{j max}$   | Maximum junction temperature                                                   | +150               | °C               |
| $T_{stg}$     | Storage temperature range                                                      | -40 to +125        | °C               |

#### Notes:

- De-rating factor of 0.13% per °C is applicable for  $T_j$  below 25°C.
- Single phase; 50 Hz, 180° half-sinewave.
- Half-sinewave, 150°C  $T_j$  initial.
- AC RMS voltage, 50 Hz, 1min test.

**Characteristics**

|            | PARAMETER                            | TEST CONDITIONS <sup>1)</sup>                                                                                   | MIN. | TYP. | MAX.  | UNITS |
|------------|--------------------------------------|-----------------------------------------------------------------------------------------------------------------|------|------|-------|-------|
| $V_{FM}$   | Maximum peak forward voltage         | $I_{TM} = 1800 \text{ A}$                                                                                       | -    | -    | 1.15  | V     |
| $V_{FM}$   | Maximum peak forward voltage         | $I_{TM} = 500 \text{ A}$                                                                                        | -    | -    | 0.88  |       |
| $V_{T0}$   | Threshold voltage                    |                                                                                                                 | -    | -    | 0.75  | V     |
| $r_T$      | Slope resistance                     |                                                                                                                 | -    | -    | 0.2   | mΩ    |
| $I_{RRM}$  | Peak reverse current                 | Rated $V_{RRM}$                                                                                                 | -    | -    | 50    | mA    |
| $Q_{rr}$   | Recovered Charge                     | $I_{TM} = 1000 \text{ A}$ , $t_p = 1 \text{ ms}$ ,<br>$di/dt = 10 \text{ A}/\mu\text{s}$ , $V_r = 50 \text{ V}$ | -    | 1800 | -     | μC    |
| $Q_{ra}$   | Recovered Charge, 50% chord          |                                                                                                                 | -    | 1500 | 1750  | μC    |
| $I_{RM}$   | Reverse recovery current             |                                                                                                                 | -    | 165  | -     | A     |
| $t_{rr}$   | Reverse recovery time, 50% chord     |                                                                                                                 | -    | 18   | -     | μs    |
| $R_{thJC}$ | Thermal resistance, junction to case | Single Diode                                                                                                    | -    | -    | 0.062 | K/W   |
|            |                                      | Whole Module                                                                                                    | -    | -    | 0.031 | K/W   |
| $R_{thCK}$ | Thermal resistance, case to heatsink | Single Diode                                                                                                    | -    | -    | 0.02  | K/W   |
|            |                                      | Whole Module                                                                                                    | -    | -    | 0.01  | K/W   |
| $F_1$      | Mounting force (to heatsink)         | <sup>2)</sup>                                                                                                   | 4.25 | -    | 5.75  | Nm    |
| $F_2$      | Mounting force (to terminals)        |                                                                                                                 | 10.2 | -    | 13.8  | Nm    |
| $W_t$      | Weight                               |                                                                                                                 | -    | 1.2  | -     | kg    |

**Notes:**1) Unless otherwise indicated  $T_j = 150^\circ\text{C}$ 

2) Screws must be lubricated

**Notes on Ratings and Characteristics****1.0 Voltage Grade Table**

| Voltage Grade | $V_{RRM}$<br>V | $V_{RSM}$<br>V | $V_R$<br>DC V |
|---------------|----------------|----------------|---------------|
| 12            | 1200           | 1300           | 820           |
| 14            | 1400           | 1500           | 930           |
| 16            | 1600           | 1700           | 1040          |
| 18            | 1800           | 1900           | 1150          |
| 20            | 2000           | 2100           | 1260          |
| 22            | 2200           | 2300           | 1370          |

**2.0 Extension of Voltage Grades**

This report is applicable to other voltage grades when supply has been agreed by Sales/Production.

**3.0 De-rating Factor**

A blocking voltage de-rating factor of 0.13%/°C is applicable to this device for  $T_j$  below 25°C.

**4.0 Snubber Components**

When selecting snubber components, care must be taken not to use excessively large values of snubber capacitor or excessively small values of snubber resistor. Such excessive component values may lead to device damage due to the large resultant values of snubber discharge current. If required, please consult the factory for assistance.

**5.0 Computer Modelling Parameters****5.1 Device Dissipation Calculations**

$$I_{AV} = \frac{-V_{T0} + \sqrt{V_{T0}^2 + 4 \cdot ff^2 \cdot r_T \cdot W_{AV}}}{2 \cdot ff^2 \cdot r_T} \quad \text{and:} \quad W_{AV} = \frac{\Delta T}{R_{th}}$$

$$\Delta T = T_{j \max} - T_K$$

Where  $V_{T0}=0.75V$ ,  $r_T=0.2m\Omega$ ,

$R_{th}$  = Supplementary thermal impedance, see table below and

$ff$  = Form factor, see table below.

| Supplementary Thermal Impedance |             |             |             |             |             |         |       |
|---------------------------------|-------------|-------------|-------------|-------------|-------------|---------|-------|
| Conduction Angle                | 30°         | 60°         | 90°         | 120°        | 180°        | 270°    | d.c.  |
| Square wave                     | 0.0706<br>7 | 0.0679<br>1 | 0.0662<br>9 | 0.0652<br>5 | 0.0639<br>5 | 0.06277 | 0.062 |
| Sine wave                       | 0.0676<br>7 | 0.0653<br>6 | 0.0640<br>8 | 0.0633      | 0.062       |         |       |

| Form Factors     |       |       |      |       |       |       |      |
|------------------|-------|-------|------|-------|-------|-------|------|
| Conduction Angle | 30°   | 60°   | 90°  | 120°  | 180°  | 270°  | d.c. |
| Square wave      | 3.464 | 2.449 | 2    | 1.732 | 1.414 | 1.149 | 1    |
| Sine wave        | 3.98  | 2.778 | 2.22 | 1.879 | 1.57  |       |      |

## 5.2 Calculating $V_F$ using ABCD Coefficients

The on-state characteristic  $I_F$  vs.  $V_F$ , on page 6 is represented in two ways;

- (i) the well established  $V_{T0}$  and  $r_T$  tangent used for rating purposes and
- (ii) a set of constants A, B, C, D, forming the coefficients of the representative equation for  $V_F$  in terms of  $I_F$  given below:

$$V_F = A + B \cdot \ln(I_F) + C \cdot I_F + D \cdot \sqrt{I_F}$$

The constants, derived by curve fitting software, are given below for both hot and cold characteristics. The resulting values for  $V_F$  agree with the true device characteristic over a current range, which is limited to that plotted.

| 25°C Coefficients |                           | 150°C Coefficients |                            |
|-------------------|---------------------------|--------------------|----------------------------|
| A                 | 0.46164273                | A                  | 0.435837127                |
| B                 | 0.1048225                 | B                  | 0.06435749                 |
| C                 | $1.6116 \times 10^{-4}$   | C                  | $1.84243 \times 10^{-4}$   |
| D                 | $-7.48063 \times 10^{-3}$ | D                  | $-2.353947 \times 10^{-3}$ |

### 5.3 D.C. Thermal Impedance Calculation

$$r_t = \sum_{p=1}^{p=n} r_p \cdot \left( 1 - e^{\frac{-t}{\tau_p}} \right)$$

Where  $p = 1$  to  $n$ ,  $n$  is the number of terms in the series and:

$t$  = Duration of heating pulse in seconds.

$r_t$  = Thermal resistance at time  $t$ .

$r_p$  = Amplitude of  $p_{th}$  term.

$\tau_p$  = Time Constant of  $r_{th}$  term.

The coefficients for this device are shown in the tables below:

| D.C.     |         |                         |                         |                         |
|----------|---------|-------------------------|-------------------------|-------------------------|
| Term     | 1       | 2                       | 3                       | 4                       |
| $r_p$    | 0.05428 | $4.4894 \times 10^{-3}$ | $2.3382 \times 10^{-3}$ | $0.8759 \times 10^{-3}$ |
| $\tau_p$ | 2.69428 | 0.126017                | 0.013878                | $1.435 \times 10^{-3}$  |

### 6.0 Reverse recovery ratings

(i)  $Q_{ra}$  is based on 50%  $I_{RM}$  chord as shown in Fig. 1

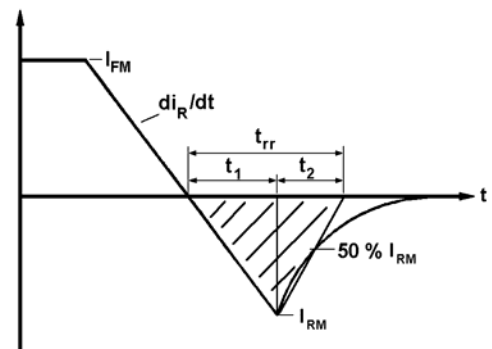


Fig. 1

(ii)  $Q_{rr}$  is based on a  $150 \mu s$  integration time i.e.

$$Q_{rr} = \int_0^{150 \mu s} i_{rr} \cdot dt$$

(iii)

$$K \text{ Factor} = \frac{t_1}{t_2}$$

## Curves

Figure 1 - Forward characteristics of Limit device

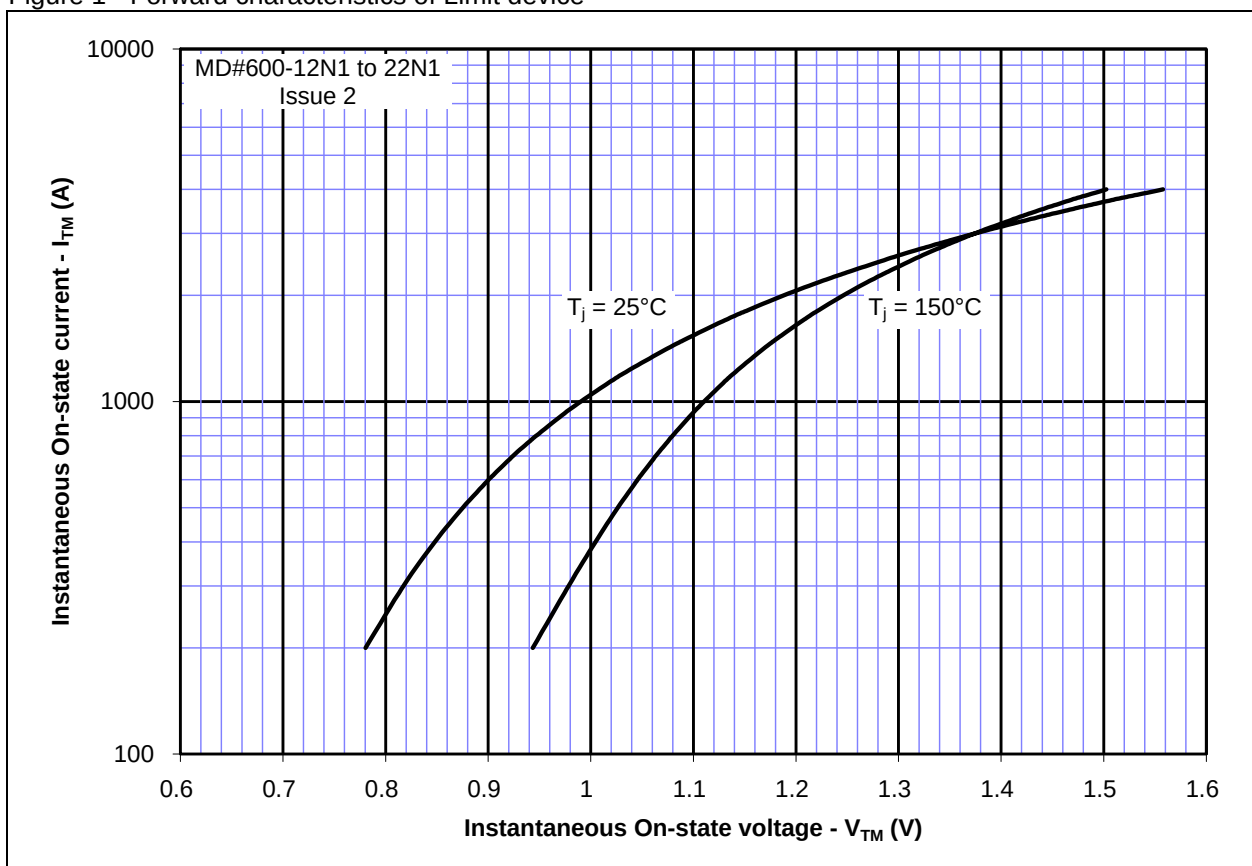


Figure 2 - Transient thermal impedance

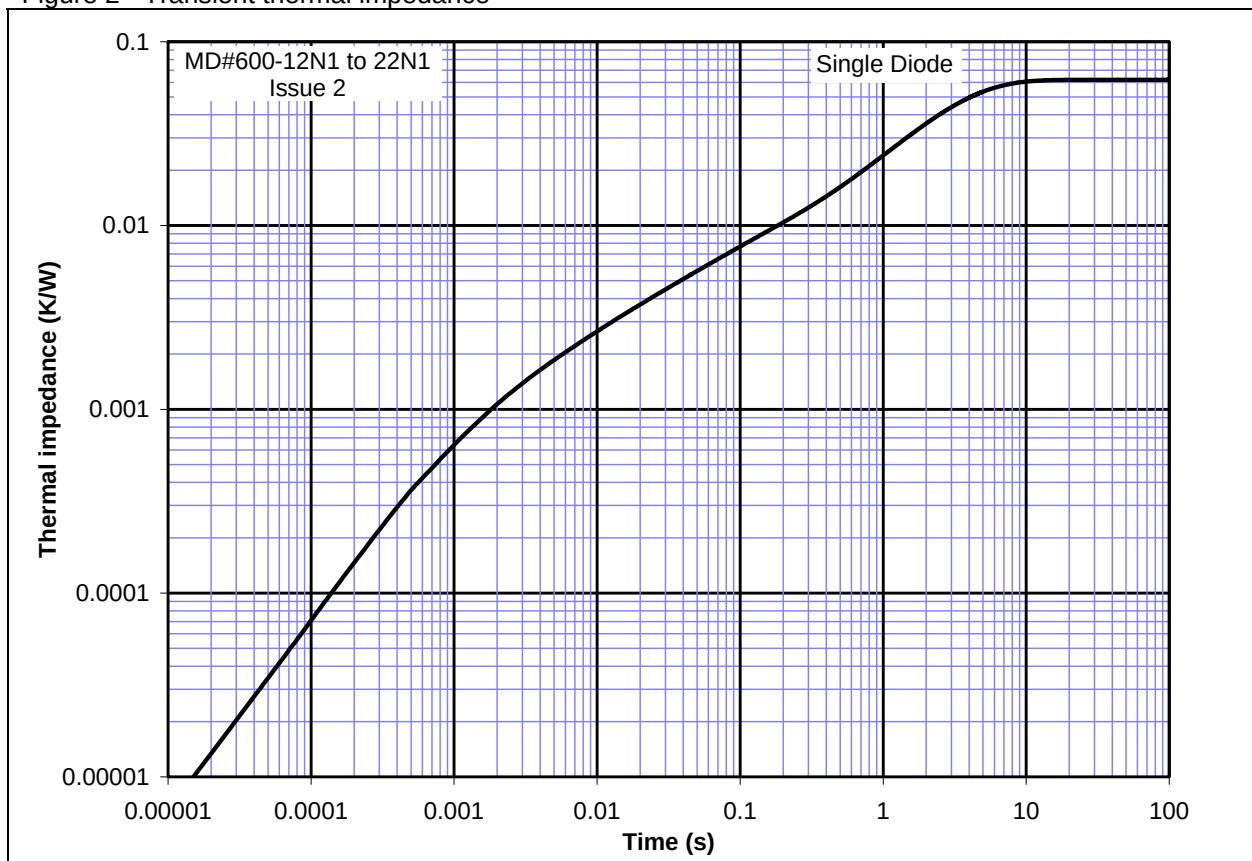


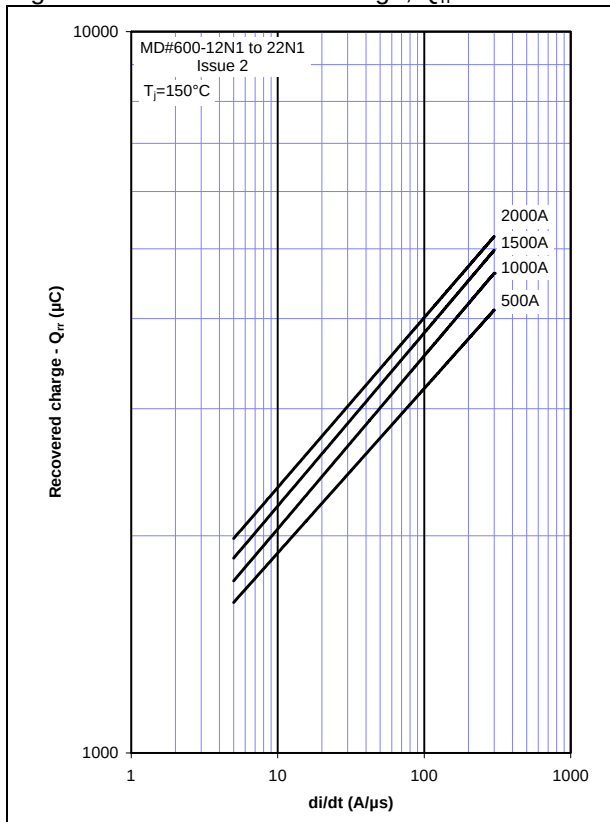
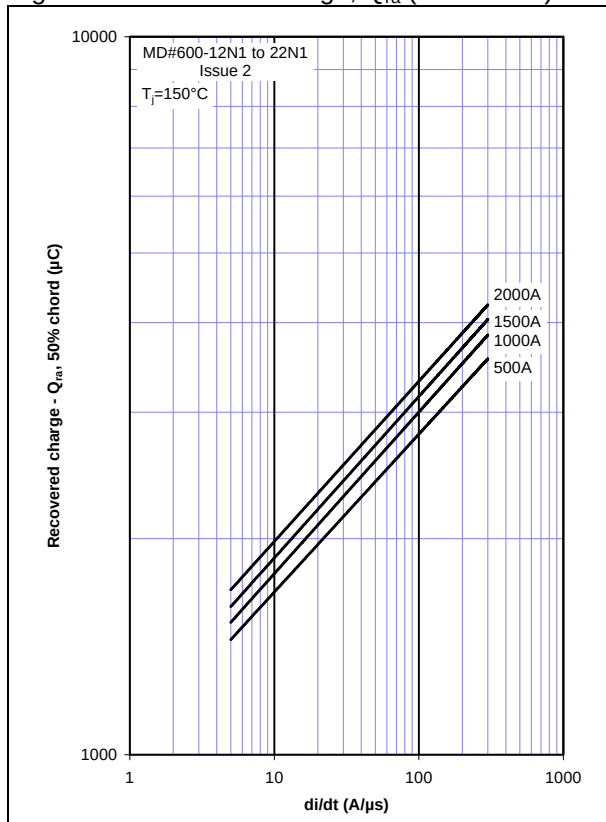
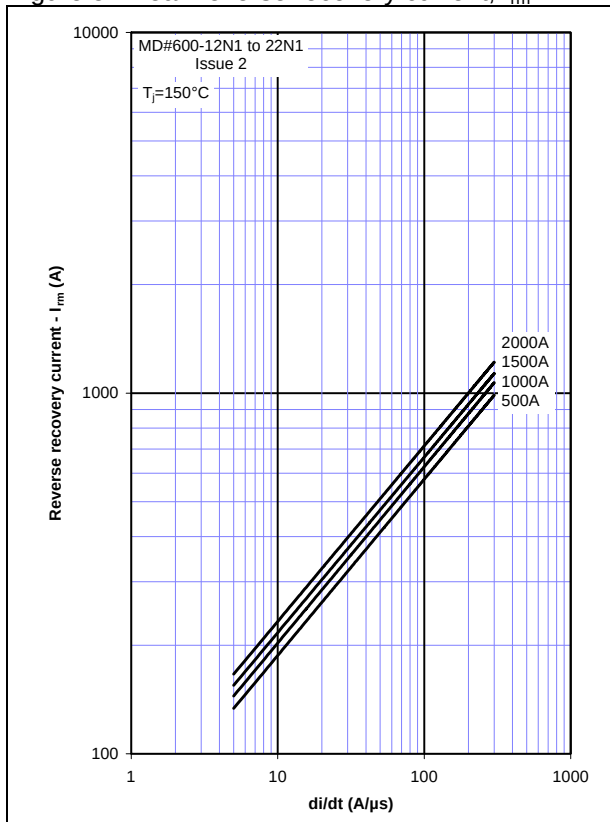
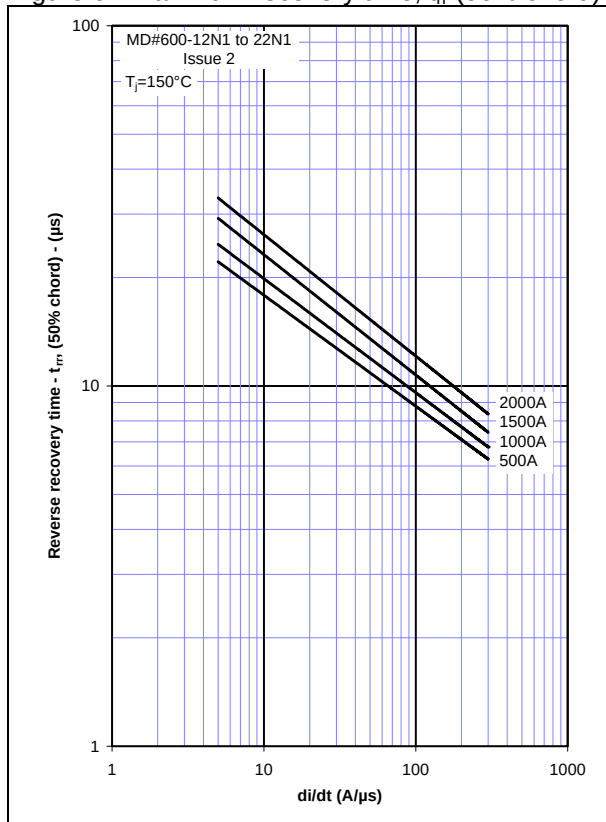
Figure 3 - Total recovered charge,  $Q_{rr}$ Figure 4 - Recovered charge,  $Q_{ra}$  (50% chord)Figure 5 - Peak reverse recovery current,  $I_{rm}$ Figure 6 - Maximum recovery time,  $t_{rr}$  (50% chord)

Figure 7 – Forward current vs. Power dissipation

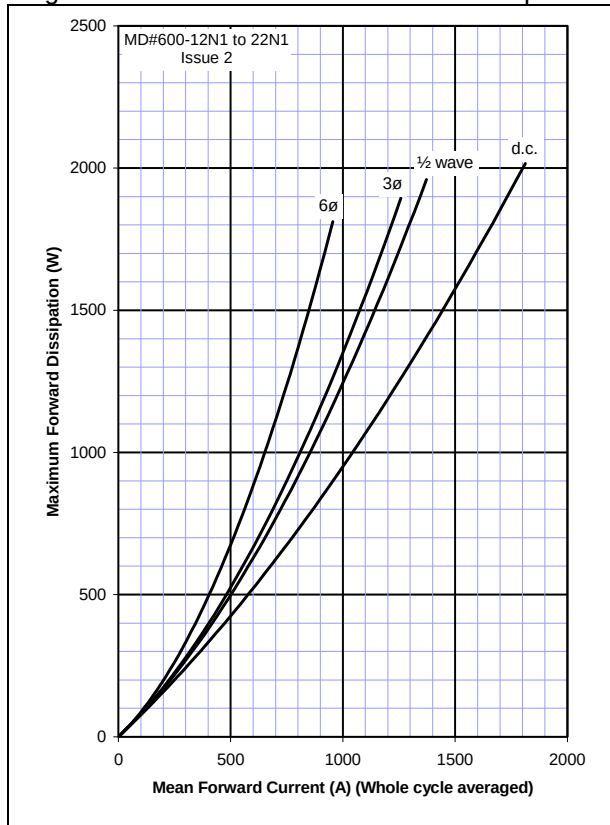


Figure 8 – Forward current vs. Heatsink temperature

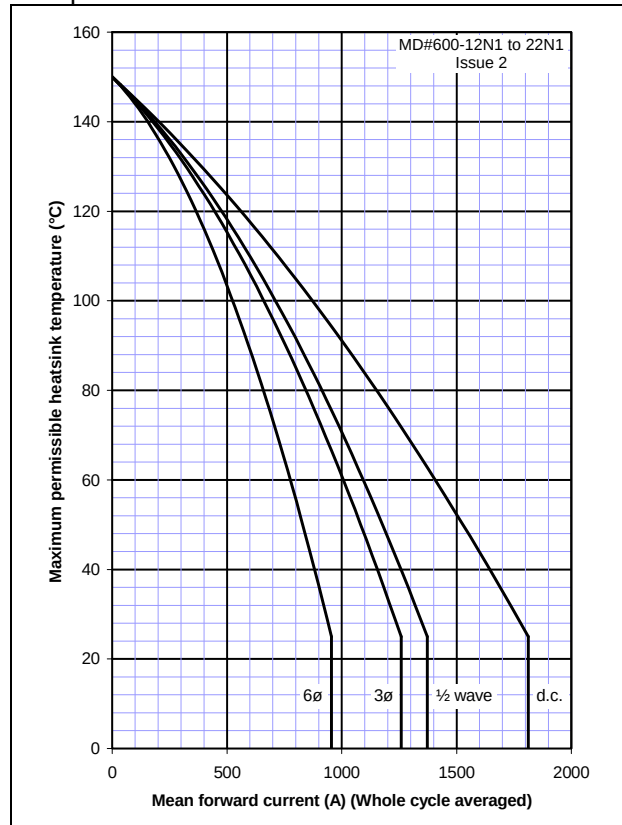
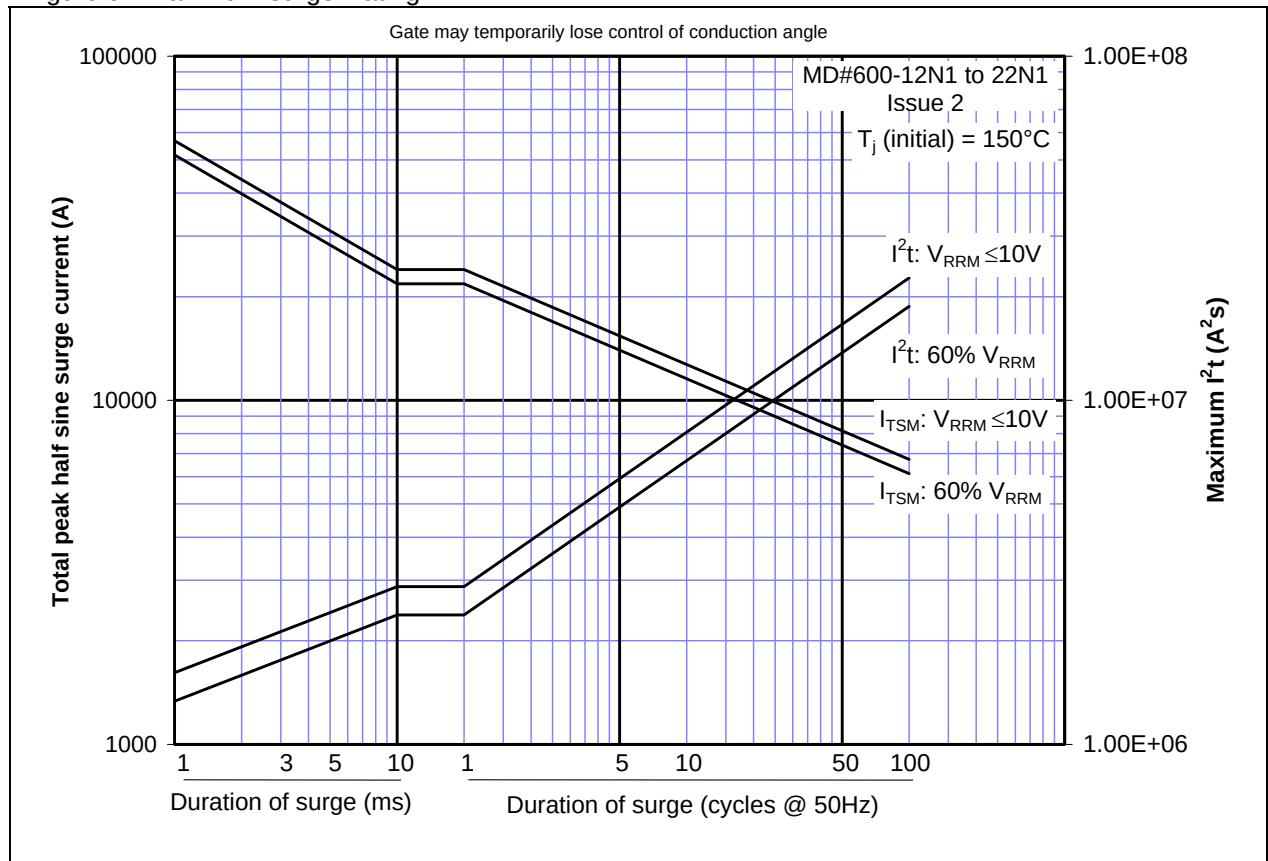
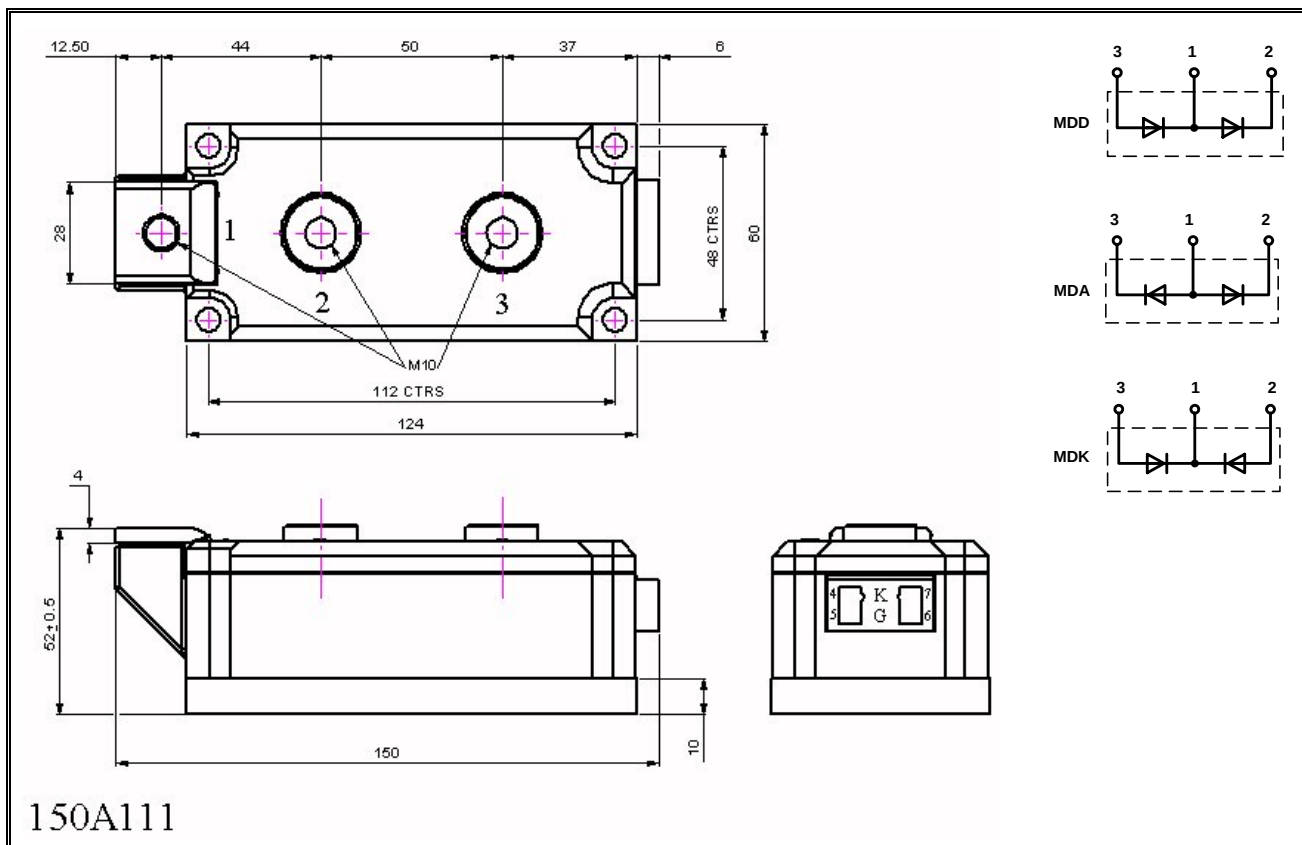


Figure 9 - Maximum surge Rating





## Outline Drawing &amp; Ordering Information



## ORDERING INFORMATION

(Please quote 11 digit code as below)

| M                  | D#                               | 600                       | ◆◆                                     | N              | 1                     |
|--------------------|----------------------------------|---------------------------|----------------------------------------|----------------|-----------------------|
| Fixed<br>Type Code | Configuration code<br>DD, DA, DK | Average Current<br>Rating | Voltage code<br>$V_{DRM}/100$<br>12-22 | Standard diode | Fixed<br>Version Code |

Order code: MDD600-14N1- MDD configuration, 1400V  $V_{DRM}$ ,  $V_{RRM}$ 

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